

MPSW56RLRA Datasheet



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DiGi Electronics Part Number MPSW56RLRA-DG

Manufacturer onsemi

Manufacturer Product Number MPSW56RLRA

Description TRANS PNP 80V 0.5A TO92

Detailed Description Bipolar (BJT) Transistor PNP 80 V 500 mA 50MHz 1 W

Through Hole TO-92 (TO-226)



Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

DiGi is a global authorized distributor of electronic components.



Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
MPSW56RLRA	onsemi
Series:	Product Status:
	Obsolete
Transistor Type:	Current - Collector (Ic) (Max):
PNP	500 mA
Voltage - Collector Emitter Breakdown (Max):	Vce Saturation (Max) @ lb, lc:
80 V	500mV @ 10mA, 250mA
Current - Collector Cutoff (Max):	DC Current Gain (hFE) (Min) @ Ic, Vce:
500nA	50 @ 250mA, 1V
Power - Max:	Frequency - Transition:
1 W	50MHz
Operating Temperature:	Mounting Type:
-55°C ~ 150°C (TJ)	Through Hole
Package / Case:	Supplier Device Package:
TO-226-3, TO-92-3 Long Body (Formed Leads)	TO-92 (TO-226)
Base Product Number:	
MPSW56	

Environmental & Export classification

8541.29.0075

RoHS Status:	Moisture Sensitivity Level (MSL):
RoHS non-compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	

MPSW55, MPSW56

One Watt Amplifier Transistors

PNP Silicon

Features

• Pb-Free Packages are Available*

MAXIMUM RATINGS

Rating		Symbol	Value	Unit
Collector - Emitter Voltage	MPSW55 MPSW56	V _{CEO}	-60 -80	Vdc
Collector - Base Voltage	MPSW55 MPSW56	V _{CBO}	-60 -80	Vdc
Emitter - Base Voltage		V _{EBO}	-4.0	Vdc
Collector Current - Continuous	;	I _C	-500	mAdc
Total Device Dissipation @ T _A : Derate above 25°C	P _D	1.0 8.0	W mW/°C	
Total Device Dissipation @ T _C Derate above 25°C	= 25°C	P _D	2.5 20	W mW/°C
Operating and Storage Junction Temperature Range	n	T _J , T _{stg}	-55 to +150	°C

THERMAL CHARACTERISTICS

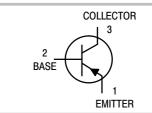
Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	125	°C/W
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	50	°C/W

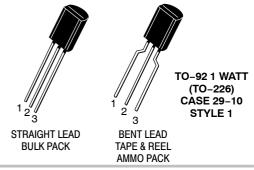
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.



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MARKING DIAGRAM



x = 5 or 6

A = Assembly Location

Y = Year WW = Work Week = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]
MPSW55G	TO-92 (Pb-Free)	5000 Units/Bulk
MPSW55RLRAG	TO-92 (Pb-Free)	2000/Tape & Reel
MPSW56RLRP	TO-92	2000/Ammo Pack
MPSW56RLRPG	TO-92 (Pb-Free)	2000/Ammo Pack

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

MPSW55, MPSW56

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit	
OFF CHARACTERISTICS					
Collector – Emitter Breakdown Voltage (Note 1) $(I_C = -1.0 \text{ mAdc}, I_B = 0)$	MPSW55 MPSW56	V _{(BR)CEO}	-60 -80	- -	Vdc
Emitter – Base Breakdown Voltage ($I_E = -100 \mu Adc$, $I_C = 0$)		V _{(BR)EBO}	-4.0	-	Vdc
Collector Cutoff Current $(V_{CE} = -40 \text{ Vdc}, I_B = 0)$ $(V_{CE} = -60 \text{ Vdc}, I_B = 0)$	MPSW55 MPSW56	Ices	- -	-0.5 -0.5	μAdc
Collector Cutoff Current $(V_{CB} = -40 \text{ Vdc}, I_E = 0)$ $(V_{CB} = -60 \text{ Vdc}, I_E = 0)$	MPSW55 MPSW56	Ісво	- -	-0.1 -0.1	μAdc
Emitter Cutoff Current $(V_{EB} = -3.0 \text{ Vdc}, I_C = 0)$		I _{EBO}	-	-0.1	μAdc
ON CHARACTERISTICS ⁽¹⁾					
DC Current Gain		h _{FE}	100 50	- -	-
Collector – Emitter Saturation Voltage $(I_C = -250 \text{ mAdc}, I_B = -10 \text{ mAdc})$		V _{CE(sat)}	-	-0.5	Vdc
Base-Emitter On Voltage (I _C = -250 mAdc, V _{CE} = -5.0 Vdc)		V _{BE(on)}	-	-1.2	Vdc
SMALL-SIGNAL CHARACTERISTICS				•	
Current – Gain — Bandwidth Product (I _C = -250 mAdc, V _{CE} = -5.0 Vdc, f = 20 MHz)		f _T	50	-	MHz
Output Capacitance (V _{CB} = -10 Vdc, f = 1.0 MHz)		C _{obo}	-	15	pF

Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2.0%.

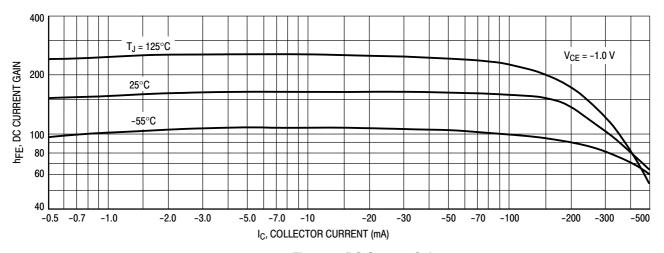
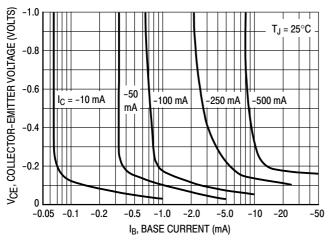


Figure 1. DC Current Gain

MPSW55, MPSW56



-1.0

T_J = 25°C

-0.8

V_{BE(sat)} @ I_C/I_B = 10

V_{BE(on)} @ V_{CE} = -1.0 V

-0.2

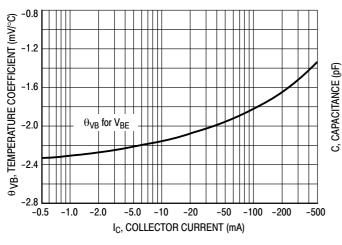
V_{CE(sat)} @ I_C/I_B = 10

-0.5 -1.0 -2.0 -5.0 -10 -20 -50 -100 -200 -500

I_C, COLLECTOR CURRENT (mA)

Figure 2. Collector Saturation Region

Figure 3. "On" Voltages



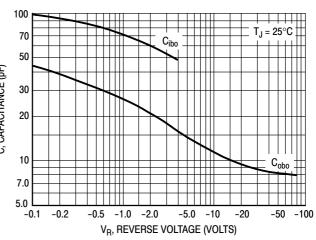
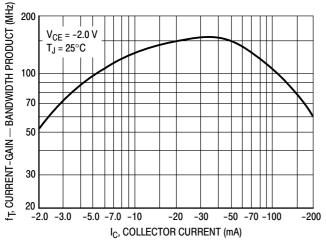


Figure 4. Base-Emitter Temperature Coefficient

Figure 5. Capacitance



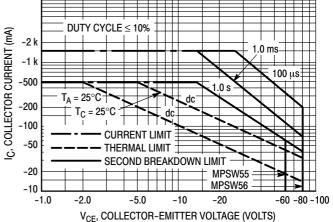


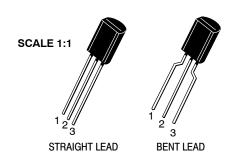
Figure 6. Current-Gain — Bandwidth Product

Figure 7. Active Region — Safe Operating Area



MECHANICAL CASE OUTLINE

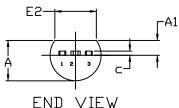
PACKAGE DIMENSIONS

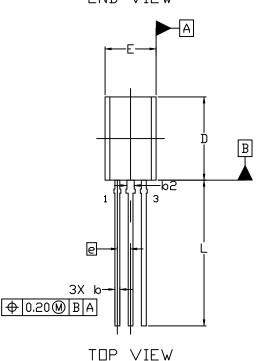


TO-92 (TO-226) 1 WATT CASE 29-10 ISSUE D

DATE 05 MAR 2021

STRAIGHT LEAD





NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- 3. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR GATE PROTRUSIONS.
- 4. DIMENSION 6 AND 62 DOES NOT INCLUDE DAMBAR PROTRUSION. LEAD WIDTH INCLUDING PROTRUSION SHALL NOT EXCEED 0.20. DIMENSION 62 LOCATED ABOVE THE DAMBAR PORTION OF MIDDLE LEAD.

	MILLIMETERS						
DIM	MIN.	N□M.	MAX.				
Α	3.75	3.90	4.05				
A1	1.28	1.43	1.58				
b	0.38	0.465	0.55				
b2	0.62	0.70	0.78				
c	0.35	0.40	0.45				
D	7.85	8.00	8.15				
E	4.75	4.90	5.05				
E2	3.90						
е	1.27 BSC						
L	13.80 14.00 14.20						

STYLES AND MARKING ON PAGE 3

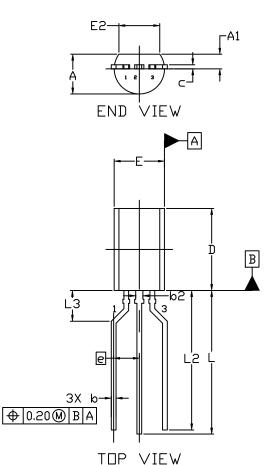
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FORMED LEAD



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D	7.85	8.00	8.15				
E	4.75	4.90	5.05				
E2	3.90						
е	2.50 BSC						
L	13.80	14.00	14.20				
L2	13.20	13.60	14.00				
L3	3.00 REF						

STYLES AND MARKING ON PAGE 3

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DATE 05 MAR 2021

STYLE 1: PIN 1. 2. 3.	EMITTER BASE COLLECTOR	PIN 1	BASE	STYLE 3: PIN 1. 2. 3.	ANODE	PIN 1	CATHODE CATHODE ANODE	2.	DRAIN SOURCE GATE
	GATE	PIN 1. 2.	SOURCE DRAIN	PIN 1. 2.	DRAIN	2.	BASE 1		
2.	CATHODE & ANODE	2.	MAIN TERMINAL 1 GATE MAIN TERMINAL 2	STYLE 13: PIN 1. 2. 3.	GATE	PIN 1.	EMITTER	STYLE 15: PIN 1. 2. 3.	
STYLE 16: PIN 1. 2. 3.	ANODE GATE CATHODE	STYLE 17: PIN 1. 2. 3.	COLLECTOR BASE EMITTER	STYLE 18: PIN 1. 2. 3.	ANODE CATHODE NOT CONNECTED	STYLE 19: PIN 1. 2. 3.	GATE ANODE CATHODE	PIN 1. 2.	NOT CONNECTED CATHODE ANODE
2.	COLLECTOR EMITTER BASE	PIN 1. 2.	SOURCE GATE DRAIN	PIN 1. 2.	GATE	PIN 1. 2.	EMITTER COLLECTOR/ANODE CATHODE	PIN 1. 2.	MT 1
	V _{CC}	PIN 1.	MT SUBSTRATE	PIN 1. 2.	CATHODE	PIN 1. 2.	NOT CONNECTED ANODE CATHODE	PIN 1. 2.	
	GATE DRAIN SOURCE			STYLE 33: PIN 1. 2. 3.	RETURN	PIN 1. 2.	INPUT GROUND LOGIC		

GENERIC MARKING DIAGRAM*



XXXX = Specific Device Code

A = Assembly Location

L = Wafer Lot Y = Year

W = Work Week

= Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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